

SUPPLEMENTARY EUROPEAN SEARCH REPORT

Application Number
EP 14 88 2156

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (IPC)
X	US 2005/269926 A1 (FUKUOKA NOBUHIKO [JP] ET AL) 8 December 2005 (2005-12-08)	1,3-5, 7-13,15	INV. H01L51/50
Y	* paragraph [0090]; figure 2D * * paragraph [0047] * * paragraph [0056] * * paragraph [0061] * * paragraph [0064] * * paragraph [0083] - paragraph [0090] * -----	14	H01L51/52 H01L51/54 H01L23/29
X	US 2006/284556 A1 (TREMEL JAMES D [US] ET AL) 21 December 2006 (2006-12-21)	1-10	
Y	* paragraph [0070] - paragraph [0072] * -----	14	
			TECHNICAL FIELDS SEARCHED (IPC)
			H01L B01J
The supplementary search report has been based on the last set of claims valid and available at the start of the search.			
Place of search The Hague		Date of completion of the search 30 January 2018	Examiner Klemps, Christian
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 14 88 2156

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report.
The members are as contained in the European Patent Office EDP file on
The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

30-01-2018

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
US 2005269926 A1	08-12-2005	CN 1703123 A	30-11-2005
		JP 2005340020 A	08-12-2005
		US 2005269926 A1	08-12-2005

US 2006284556 A1	21-12-2006	NONE	

专利名称(译)	用于包装电子器件的组合物以及包装方法和OLED显示装置		
公开(公告)号	EP3174114A4	公开(公告)日	2018-03-07
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申请(专利权)人(译)	京东方科技集团股份有限公司.		
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[标]发明人	HONG RUI WANG DAN FUJINO SEIJI		
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CPC分类号	B01J20/165 B01J20/06 B01J20/10 C03C3/21 C03C8/08 C03C8/24 C03C2205/00 H01L51/5246 H01L51/5259 H01L51/56		
审查员(译)	KLEMPs , CHRISTIAN		
优先权	201410334114.X 2014-07-14 CN		
其他公开文献	EP3174114A1 EP3174114B1		
外部链接	Espacenet		

摘要(译)

用于包装电子器件的组合物包含基质和具有水蒸汽吸附能力的吸附材料，并且吸附材料包括绿坡缕石和/或沸石。通过添加具有吸附作用的凹凸棒石和/或沸石来改变玻璃料的配方，用于包装电子器件的组合物可以有效地减少水蒸气对电子器件的影响，从而有效地延长封装电子器件的寿命。。

DOCUMENTS CONSIDERED TO BE RELEVANT		Relevant to claim	CLASSIFICATION OF THE APPLICATION (IPC)
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X	US 2005/269926 A1 (FUKUOKA NOBUHIKO [JP] ET AL) 8 December 2005 (2005-12-08) * paragraph [0090]; figure 2D *	1-3+5, 7-13, 15 14	INV. H01L51/50 H01L51/52 H01L51/54 H01L23/29
Y	* paragraph [0056] * * paragraph [0061] * * paragraph [0064] * * paragraph [0083] - paragraph [0090] *		
X	US 2006/284556 A1 (TREMEL JAMES D [US] ET AL) 21 December 2006 (2006-12-21) * paragraph [0070] - paragraph [0072] *	1-10 14	
Y			
The applicant's search report has been taken into account for the text and claims of the application as filed.			
The date of publication of the application is 30 January 2018.		The name of the applicant is Klempe, Christian	
CATEGORY OF CITED DOCUMENTS		REMARKS	
1. Document cited in the application 2. Document cited in the application 3. Document cited in the application 4. Document cited in the application 5. Document cited in the application 6. Document cited in the application 7. Document cited in the application 8. Document cited in the application 9. Document cited in the application 10. Document cited in the application 11. Document cited in the application 12. Document cited in the application 13. Document cited in the application 14. Document cited in the application 15. Document cited in the application 16. Document cited in the application 17. Document cited in the application 18. Document cited in the application 19. Document cited in the application 20. Document cited in the application 21. Document cited in the application 22. Document cited in the application 23. Document cited in the application 24. Document cited in the application 25. Document cited in the application 26. Document cited in the application 27. 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